

Dear Admissions Committee,

Subject: Application for Admission to PhD in Economics

I am writing to express my strong interest in applying for the PhD in Economics at University of Chicago. As someone who is deeply passionate about economics, I am eager to contribute to and benefit from the academic excellence and vibrant community that University of Chicago is renowned for.

I am currently a student at Renmin University of China, and I have consistently demonstrated a commitment to academic achievement and personal growth. My academic background in microeconomics has equipped me with a solid foundation in economics, and I am excited to further develop these skills through the rigorous curriculum offered by University of Chicago.

Beyond academics, I have actively engaged in academic project. For example, one of my most rewarding academic experiences was leading a team project in my Advanced Microeconomics course, where we analyzed the impact of price elasticity on consumer behavior in the fast-food industry. Inspired by my interest in understanding how economic principles shape real-world decisions, I proposed the project to explore how changes in pricing strategies affect demand for products like burgers and fries. These experiences have not only strengthened my academic skills, but have also deepened my understanding of microeconomics.

What draws me most to University of Chicago is its innovative research opportunities. I am confident that studying at University of Chicago will provide me with the tools and opportunities to achieve my academic and career goals.

Upon completing my degree, I aspire to continue my education through graduate studies. I believe that University of Chicago is the ideal place to nurture my ambitions and help me make a meaningful impact in microeconomics.

Thank you for considering my application. I am excited about the possibility of joining the University of Chicago community and contributing to its legacy of excellence. I look forward to the opportunity to discuss my application further and am happy to provide any additional information if needed.

Yours sincerely,
Hongming Liang